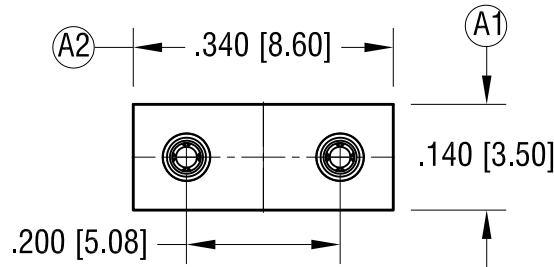
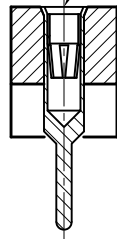


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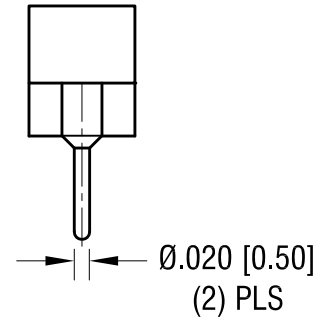
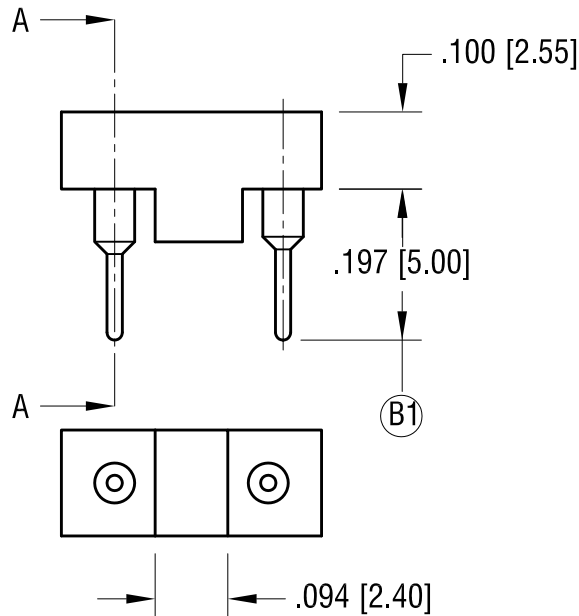
ACTUAL SIZE



ACCEPTS .020 [0.50]
DIA. PIN



SECTION A-A



NOTES:

1. INSULATOR:
MAT'L - THERMOPLASTIC, UL94 V-0
2. CONTACT PIN:
MAT'L - BRASS
FINISH - TIN PLATE
3. CONTACT SPRING:
MAT'L - BERYLLIUM COPPER
FINISH - GOLD PLATE

5.26.23	ADD (B1) CHANGE AS PER ECN 23-085	B
11.04.14	(A1) WAS .100, (A2) WAS .300 CHANGE AS PER ECN 14-114	A
DATE	DESCRIPTION	REV.

KEYSTONE ELECTRONICS CORP.			
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PART NAME		SUBMINIATURE FUSE HGOLDER	
MATERIAL		AS NOTED	
FINISH		AS NOTED	
DRN BY	BOONE	DATE	6.20.06
APP'D	MR	SCALE	4X
TOLERANCES	INCH [MM]	CODE	DWG NO.
DECIMAL	± .005 [± 0.13]	C	3552
ANGULAR	± 1°		
UNLESS OTHERWISE SPECIFIED			